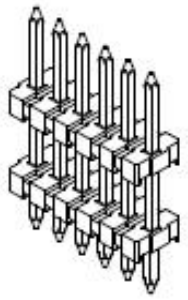
Part Number : 874471012
Product Description : 3.96mm Pitch Dual Body Header, Vertical, Through Hole, 10 Circuits, 0.38µm Gold(Au) over 1.25µ Nickel(Ni) Plating, Tube Packaging
Series Number : 87447
Status : Not Recommended For New Design
Product Category : PCB Headers and Receptacles



Documents and Resources

Drawings

874471012_sd.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Not Recommended For New Design
Category	PCB Headers and Receptacles
Series	87447
Description	3.96mm Pitch Dual Body Header, Vertical, Through Hole, 10 Circuits, 0.38µm Gold(Au) over 1.25µ Nickel(Ni) Plating, Tube Packaging
Application	Board-to-Board, Signal, Wire-to-Board
Component Type	PCB Header
Product Name	N/A
UPC	884982267596

Electrical

Current - Maximum per Contact	5.0A
Voltage - Maximum	250V

Physical

Breakaway	Yes
Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
First Mate / Last Break	No

Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	No
Lock to Mating Part	No
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Nickel
Material - Resin	High Temperature Thermoplastic
Net Weight	7.759/g
Number of Rows	1
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	No
PCB Thickness - Recommended	1.60mm
PC Tail Length	3.43mm
Pitch - Mating Interface	3.96mm
Pitch - Termination Interface	3.96mm
Plating min - Mating	0.381µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	0° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	250